



11-21-05

AF
JPW

PATENT ANL-IN-03-023

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Ruxandra Baurceanu et al.
Title : LAYERED STRUCTURE OF CU-CONTAINING
SUPERCONDUCTOR AND AG OR AG ALLOYS WITH CU
Serial No. : 10/648,052
Filing Date : August 26, 2003
Art Unit : 1754
Examiner : Colleen P. Cooke
Docket No. : ANL 273
Date : November 17, 2005

CERTIFICATE OF EXPRESS MAIL

I hereby certify that this correspondence is being forwarded via Express Mail No. EV1693419624US before the last scheduled pick-up, and addressed to: Commissioner for Patents, P.O. Box 1450, Mail Stop Non-Fee AMENDMENT, Alexandria, VA 22313-1450, on

11/18/05
Date of Deposit

Brenda Hark

MAIL STOP NO FEE AMENDMENT

Director of Patents
U.S. Patent and Trademark Office
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE AFTER FINAL

This Response replies to the FINAL Office Action dated September 16, 2005, a response to which is due December 16, 2005.

REMARKS

Reconsideration of this application is requested.

Submitted herewith is a Declaration of Dr. Balachandran, an inventor in the present case. Dr. Balachandran reviewed the Examiner's calculations of the amount of copper in